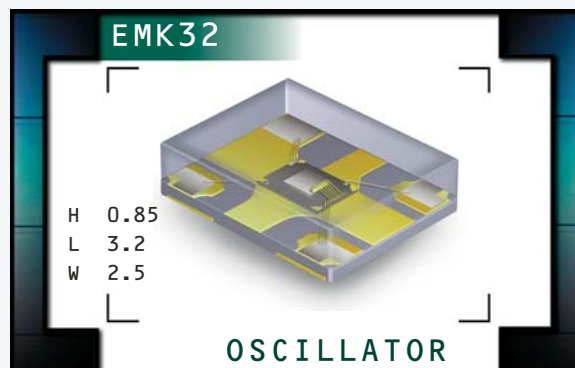




EMK32 Series

- MEMS First™ Resonator Technology
- RoHS Compliant (Pb-Free)
- 2.5mm x 3.2mm Surface Mount Package
- LVHCMOS Output
- 2.5V Supply Voltage
- Stability to ± 50 ppm
- 30,000 G Shock Resistance
- Available on Tape & Reel
- Tri-State and Power Down Options



ELECTRICAL SPECIFICATIONS

Nominal Frequency		1.000MHz to 125MHz
Operating Temperature Range		-40°C to 85°C
Storage Temperature Range		-55°C to 125°C
Supply Voltage (V_{DD})		2.5V _{DC} $\pm 5\%$
Input Current	≤ 25.000 MHz	17mA Maximum
	> 25.000 MHz	20mA Maximum
Frequency Tolerance / Stability		Inclusive of All Conditions: Calibration Tolerance at 25°C , Frequency Stability over the Operating Temperature Range, Supply Voltage Change, Output Load Change, 1st Year Aging at 25°C, 260°C Reflow, Shock, and Vibration ± 50 ppm or ± 100 ppm Maximum
Output Voltage Logic High (V_{OH})	$I_{OH} = -8$ mA	90% of V_{DD} Minimum
Output Voltage Logic Low (V_{OL})	$I_{OL} = +8$ mA	10% of V_{DD} Maximum
Rise Time / Fall Time	20% to 80% of waveform	2nSeconds Maximum
Duty Cycle	at 50% of waveform	50 ± 5 (%)
Load Drive Capability		15pF HCMOS Load Maximum
Output Control Function		Tri-State or Power Down
Output Control Input Voltage	V_{IH} of 70% of V_{DD} Minimum or No Connection	Enables Output
	V_{IL} of 30% of V_{DD} Maximum	Disables Output: High Impedance State for Tri-state, Logic Low for Power Down
Standby Current		50 μ A Maximum
Peak to Peak Jitter (tPK)	1.000MHz to 12.287999MHz	500pSec Maximum, 200pSec Typical
	12.288MHz to 125.000MHz	250pSec Maximum, 100pSec Typical
Aging	First Year at 25°C	± 1 ppm Maximum
Start Up Time		50mSec Maximum

PART NUMBERING GUIDE

EMK32 H 2 H - 50.000M TR

FREQUENCY TOLERANCE & STABILITY/
OPERATING TEMPERATURE RANGE

G=±100ppm Maximum over -40°C to +85°C
H=±50ppm Maximum over -40°C to +85°C

DUTY CYCLE

2=50% ±5%

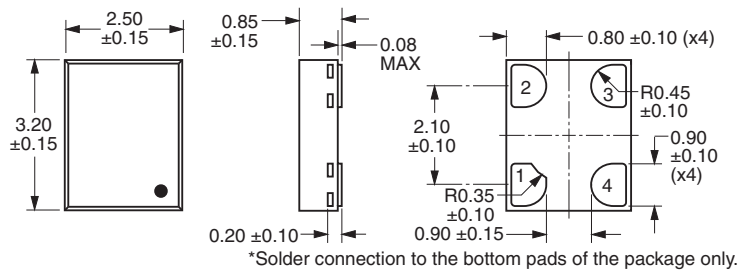
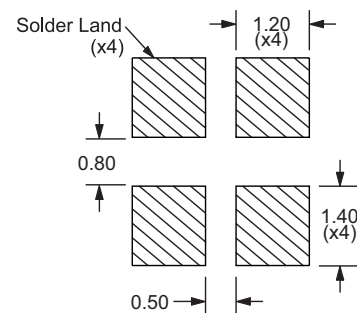
LOGIC CONTROL

H=Tri-State (High Impedance)
J=Power Down (Logic Low)

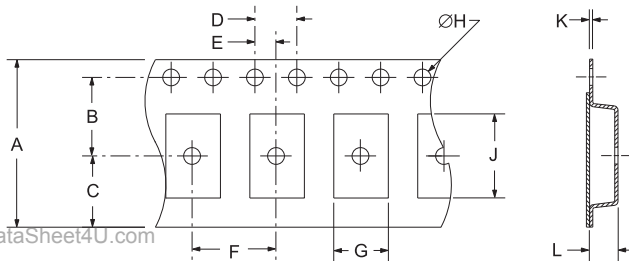
AVAILABLE OPTIONS

Blank=Bulk
TR=Tape and Reel (Standard)

FREQUENCY

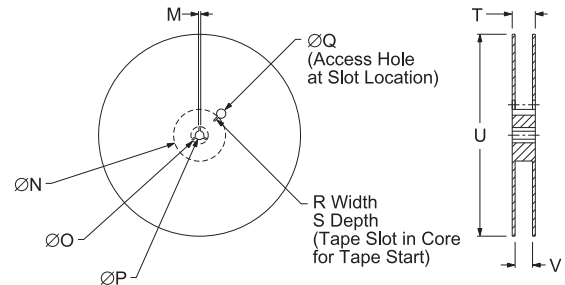
MECHANICAL DIMENSIONS
ALL DIMENSIONS IN MILLIMETERSSUGGESTED SOLDER PAD LAYOUT
ALL DIMENSIONS IN MILLIMETERS

Tolerances= ±0.1

TAPE AND REEL DIMENSIONS
ALL DIMENSIONS IN MILLIMETERS

A		B	C	D	E
12.0±0.3		5.5±0.05	4.75±.05	4.0±0.1	2.0±0.1
F	G	H	J	K	L
4.0±0.2	A0*	1.5 +1/-0	B0*	0.3 +0.05	K0*

Pin 1: Tri-State or Power Down Pin 2: Case Ground Pin 3: Output Pin 4: Supply Voltage



REEL	M	N	O	P	Q
	1.5 MIN	50 MIN	20.2 MIN	13.0 ±0.2	40 MIN
R	S	T	U	V	QTY/REEL
2.5 MIN	10 MIN	18.4 MAX	180 MAX	12.4 ±2/-0	1,000

*Compliant to EIA 481C

ENVIRONMENTAL/MECHANICAL SPECIFICATIONS

Characteristic	Specification
ESD Susceptibility	MIL-STD-883, Method 3015, Class 2, HBM: 2000V
Flammability	UL94-V0
Mechanical Shock	MIL-STD-883, Method 2002, Condition G, 30,000G
Moisture Resistance	MIL-STD-883, Method 1004
Moisture Sensitivity Level	J-STD-020, MSL 1
Resistance to Soldering Heat	MIL-STD-202, Method 210, Condition K
Resistance to Solvents	MIL-STD-202, Method 215
Solderability	MIL-STD-883, Method 2003 (Four I/O Pads on bottom of package only)
Temperature Cycling	MIL-STD-883, Method 1010, Condition B
Thermal Shock	MIL-STD-883, Method 1011, Condition B
Vibration	MIL-STD-883, Method 2007, Condition A, 20G

MEMS First™ is a registered trademark of SiTime Corporation.

MARKING SPECIFICATIONS

Line 1: XXXX

Eclipsek Manufacturing Lot Code

MANUFACTURER	CATEGORY	SERIES	PACKAGE	VOLTAGE	CLASS	REV. DATE
ECLIPTEK CORP.	OSCILLATOR	EMK32	PLASTIC	2.5V	OS5K	11/07